N-Channel Power MOSFET 60 V, 46 A, 16 m Ω

Features

- Low Gate Charge
- Fast Switching
- High Current Capability
- 100% Avalanche Tested
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	60	V
Gate-to-Source Voltage	e – Contir	nuous	V_{GS}	±20	V
Gate–to–Source Voltage – Non–Repetitive (t _p < 10 μs)			V_{GS}	±30	V
Continuous Drain		T _C = 25°C	I _D	46	Α
Current (R _{θJC})	Steady	T _C = 100°C		33	
Power Dissipation $(R_{\theta JC})$	State	T _C = 25°C	P _D	71	W
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	203	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to 175	°C
Source Current (Body Diode)			I _S	46	Α
Single Pulse Drain-to-Source (L =			E _{AS}	36	mJ
Avalanche Energy 0.1 mH)			I _{AS}	27	Α
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			T_L	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	2.1	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	49	

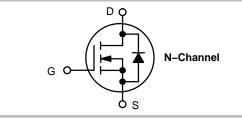
^{1.} Surface—mounted on FR4 board using a 650 $\mathrm{mm^2}$, 2 oz. Cu pad.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
60 V	16 mΩ @ 10 V	46 A	
	19 mΩ @ 4.5 V	7011	



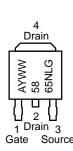


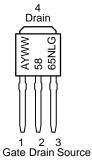
DPAK
CASE 369AA
(Surface Mount)
STYLE 2



IPAK CASE 369D (Straight Lead) STYLE 2

MARKING DIAGRAMS & PIN ASSIGNMENT





A = Assembly Location*

Y = Year

WW = Work Week 5865NL = Device Code G = Pb-Free Package

* The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

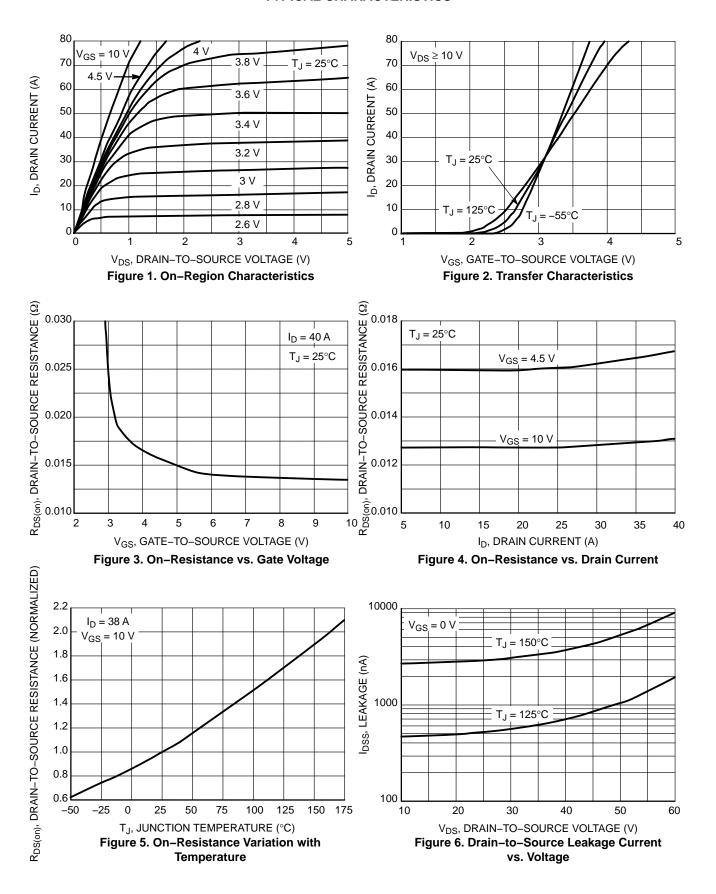
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				55		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 60 V	T _J = 25°C			1.0	μΑ
Cata to Course Leakage Current	╽		T _J = 150°C			100 ±100	nA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$; = ±20 V			±100	ΠA
ON CHARACTERISTICS (Note 2)					1		1
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 250 μΑ	1.0		2.0	V
Negative Threshold Temperature Co- efficient	V _{GS(TH)} /T _J				5.6		mV/°C
Drain-to-Source on Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D}$			13	16	mΩ
Drain-to-Source on Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{C}$	_O = 20 A		16	19	mΩ
Forward Transconductance	gFS	$V_{DS} = 15 \text{ V}, I_{D}$	₀ = 20 A		15		S
CHARGES, CAPACITANCES AND GA	TE RESISTANCE	S					
Input Capacitance	C _{iss}				1400		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V, f} = 7$ $V_{DS} = 25$	1.0 MHz, 5 V		137		-
Reverse Transfer Capacitance	C _{rss}	. D3 = 2			95		
Total Gate Charge	Q _{G(TOT)}				29		nC
Threshold Gate Charge	Q _{G(TH)}	$V_{GS} = 10 \text{ V}, V_{DS} = 48 \text{ V},$			1.1		
Gate-to-Source Charge	Q _{GS}	$I_{D} = 40$	A		4		
Gate-to-Drain Charge	Q_{GD}				8		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 4.5 \text{ V}, V_{D}$ $I_{D} = 40 \text{ A}$	os = 48 V, A		15		nC
Gate Resistance	R_{G}				1.3		Ω
SWITCHING CHARACTERISTICS (Not	te 3)						
Turn-On Delay Time	t _{d(on)}				8.4		ns
Rise Time	t _r	$V_{GS} = 10 \text{ V}, V_{D}$	_D = 48 V,		12.4		
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = 10 \text{ V}, V_{DD} = 48 \text{ V},$ $I_{D} = 40 \text{ A}, R_{G} = 2.5 \Omega$			26		
Fall Time	t _f				4.4		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	ward Diode Voltage V_{SD} $V_{GS} = 0 \text{ V}, T_{J} = 0 \text{ V}$		$T_J = 25^{\circ}C$		0.95	1.2	V
		$I_{S} = 40 \text{ A}$ $T_{J} = 125^{\circ}\text{C}$	T _J = 125°C		0.85		
Reverse Recovery Time	t _{RR}				20		ns
Charge Time	ta	V_{GS} = 0 V, dls/dt = 100 A/ μ s, I_S = 40 A			13		
Discharge Time	tb				7		
Reverse Recovery Charge	Q_{RR}				13		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width $\leq 300~\mu$ s, Duty Cycle $\leq 2\%$.

3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

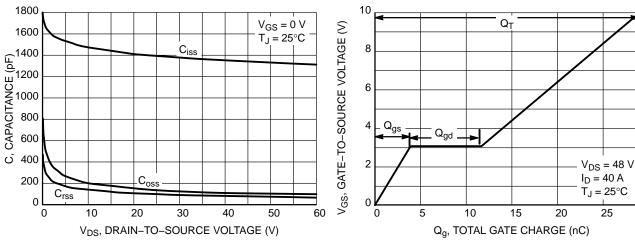


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source vs. Total Charge

30

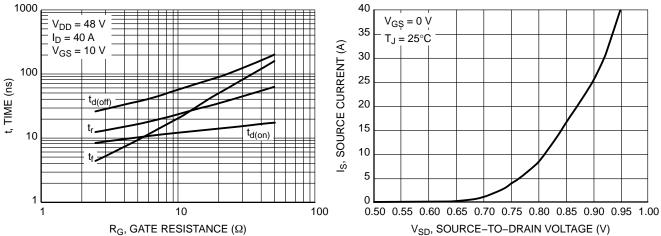


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

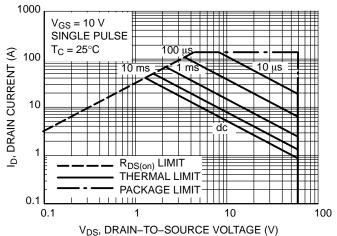


Figure 11. Maximum Rated Forward Biased Safe Operating Area

TYPICAL CHARACTERISTICS

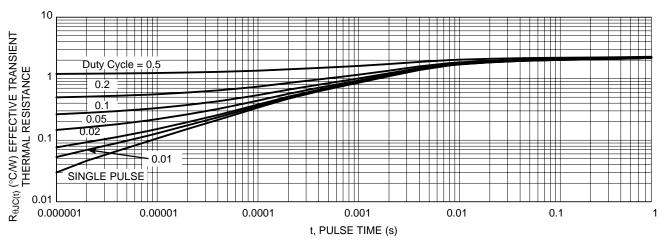


Figure 12. Thermal Response

ORDERING INFORMATION

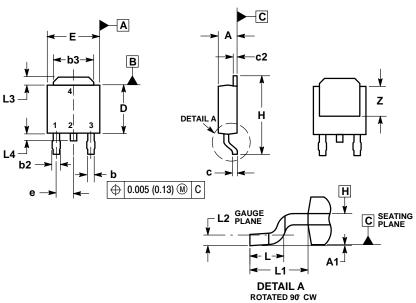
Order Number	Package	Shipping [†]
NTD5865NL-1G	IPAK (Straight Lead) (Pb-Free)	75 Units / Rail
NTD5865NLT4G	DPAK (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

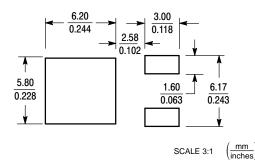
PACKAGE DIMENSIONS

DPAK (SINGLE GUAGE)

CASE 369AA **ISSUE B**



SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: INCHES.

 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS b3, L3 and Z.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.

 5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.

 6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

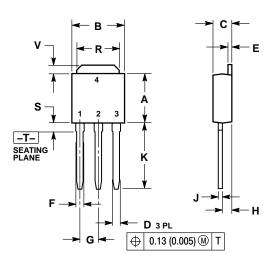
	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.030	0.045	0.76	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
Е	0.250	0.265	6.35	6.73	
е	0.090	BSC	2.29 BSC		
Н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.108	REF	2.74 REF		
L2	0.020	0.020 BSC		BSC	
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		

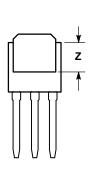
STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE

- 4. DRAIN

PACKAGE DIMENSIONS

IPAK CASE 369D **ISSUE C**





NOTES

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.235	0.245	5.97	6.35	
В	0.250	0.265	6.35	6.73	
С	0.086	0.094	2.19	2.38	
D	0.027	0.035	0.69	0.88	
Е	0.018	0.023	0.46	0.58	
F	0.037	0.045	0.94	1.14	
G	0.090	BSC	2.29 BSC		
Н	0.034	0.040	0.87	1.01	
۲	0.018	0.023	0.46	0.58	
K	0.350	0.380	8.89	9.65	
R	0.180	0.215	4.45	5.45	
S	0.025	0.040	0.63	1.01	
٧	0.035	0.050	0.89	1.27	
Z	0.155		3.93		

STYLE 2:

PIN 1. GATE 2. DRAIN

- DRAIN
- SOURCE DRAIN

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